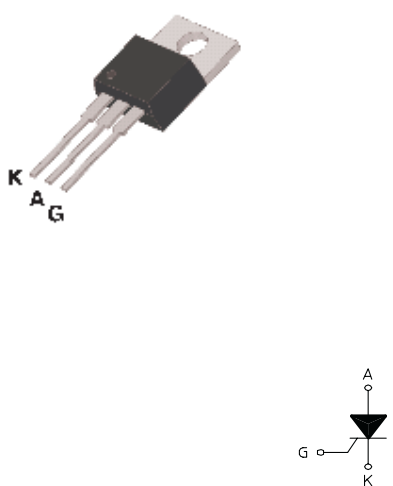


STANDARD SCR

TO-220-AB 	On-State Current Gate Trigger Current 16 Amp 2 mA to 40 mA Off-State Voltage 200 V ÷ 600 V
	These series of Silicon Controlled Rectifier use a high performance PNP technology. These parts are intended for general purpose applications where high gate sensitivity is required.

Absolute Maximum Ratings, according to IEC publication No. 134

SYMBOL	PARAMETER	CONDITIONS	Value	Unit
$I_{T(RMS)}$	On-state Current	180° Conduction Angle, $T_c = 110\text{ }^{\circ}\text{C}$	16	A
$I_{T(AV)}$	Average On-state Current	Half Cycle, $\Theta = 180\text{ }^{\circ}$, $T_c = 110\text{ }^{\circ}\text{C}$	10	A
I_{TSM}	Non-repetitive On-State Current	Half Cycle, 60 Hz	200	A
I_{TSM}	Non-repetitive On-State Current	Half Cycle, 50 Hz	190	A
I^2t	Fusing Current	$t_p = 10\text{ms}$, Half Cycle	180	A ² s
I_{GM}	Peak Gate Current	20 μs max.	4	A
P_{GM}	Peak Gate Dissipation	20 μs max.	10	W
$P_{G(AV)}$	Gate Dissipation	20ms max.	1	W
T_j	Operating Temperature		(-40 to +125)	$^{\circ}\text{C}$
T_{stg}	Storage Temperature		(-40 to +150)	$^{\circ}\text{C}$
T_{sld}	Soldering Temperature	10s max.	260	$^{\circ}\text{C}$
V_{RGM}	Reverse Gate Voltage		5	V

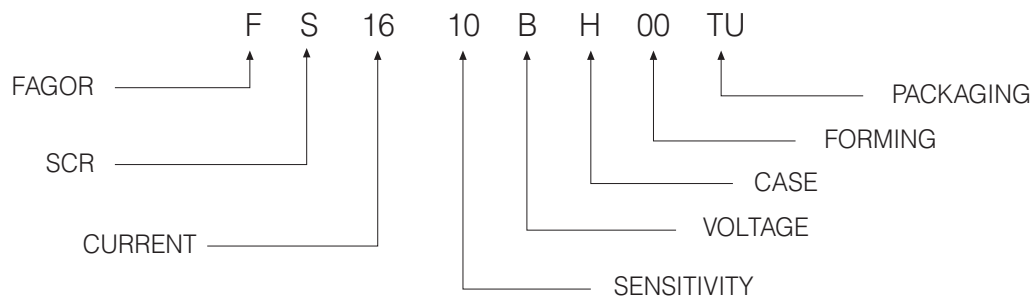
SYMBOL	PARAMETER	CONDITIONS	VOLTAGE					Unit
			B	D	M	S	N	
V_{DRM} V_{RRM}	Repetitive Peak Off State Voltage	$R_{GK} = 1\text{ k}\Omega$	200	400	600	700	800	V

STANDARD SCR

Electrical Characteristics

SYMBOL	PARAMETER	CONDITIONS		SENSITIVITY		Uni
				10	14	
I_{GT}	Gate Trigger Current	$V_D = 12 V_{DC}$, $R_L = 33\Omega$, $T_j = 25^\circ C$	MIN MAX	2 25	4 40	m A
V_{GT}	Gate Trigger Voltage	$V_D = 12 V_{DC}$, $R_L = 33\Omega$, $T_j = 25^\circ C$	MAX	1.3		V
V_{GD}	Gate Non Trigger Voltage	$V_D = V_{DRM}$, $R_L = 3.3k\Omega$, $R_{GK} = 220\Omega$, $T_j = 125^\circ C$	MIN	0.2		V
I_H	Holding Current	$I_T = 500$ mA,	MAX	40	50	mA
I_L	Latching Current	$I_G = 1.2 I_{GT}$	MAX	60	90	mA
dV / dt	Critical Rate of Voltage Rise	$V_D = 0.67 \times V_{DRM}$, Gate open, $T_j = 125^\circ C$	MIN	500	1000	V/ μ s
dI / dt	Critical Rate of Current Rise	$I_G = 2 \times I_{GT}$, $Tr \leq 100$ ns, $f = 60$ Hz, $T_j = 125^\circ C$	MIN	50		A/ μ s
V_{TM}	On-state Voltage	at $I_T = 32$ Amp, $tp = 380 \mu$ s, $T_j = 25^\circ C$	MAX	1.6		V
V_{t0}	Threshold Voltage	$T_j = 125^\circ C$	MAX	0.77		V
r_d	Dynamic resistance	$T_j = 125^\circ C$	MAX	23		m Ω
I_{DRM} / I_{RRM}	Off-State Leakage Current	$V_D = V_{DRM}$, $R_{GK} = 1k\Omega$, $T_j = 125^\circ C$	MAX	2		mA
		$V_R = V_{RRM}$, $T_j = 25^\circ C$	MAX	5		μ A
$R_{th(j-c)}$	Thermal Resistance Junction-Case for DC	for AC 360 ° conduction angle		1.1		°C/W
$R_{th(j-a)}$	Thermal Resistance Junction-Amb for DC	$S = 1$ cm ²		60		°C/W

PART NUMBER INFORMATION



STANDARD SCR

Fig. 1: Maximum average power dissipation versus average on-state current.

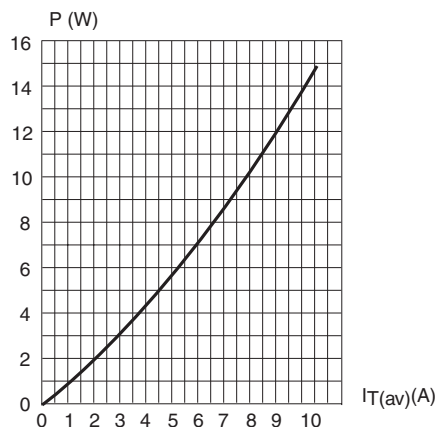


Fig. 2: Average and D.C. on-state current versus case temperature.

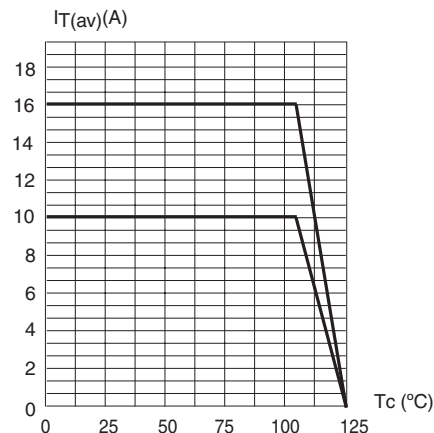


Fig. 3: Relative variation of thermal impedance junction to case versus pulse duration.

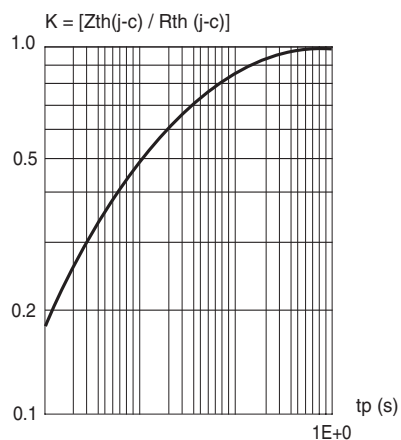


Fig. 4: Relative variation of gate trigger current, holding and latching current versus junction temperature.

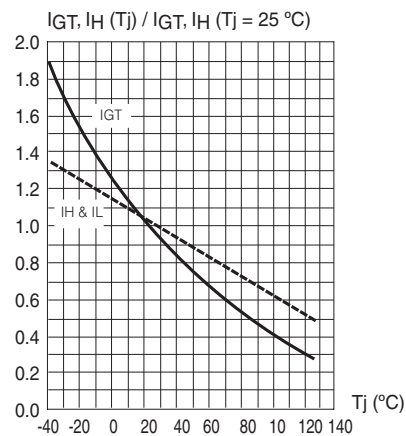


Fig. 5: Non repetitive surge peak on-state current versus number of cycles.

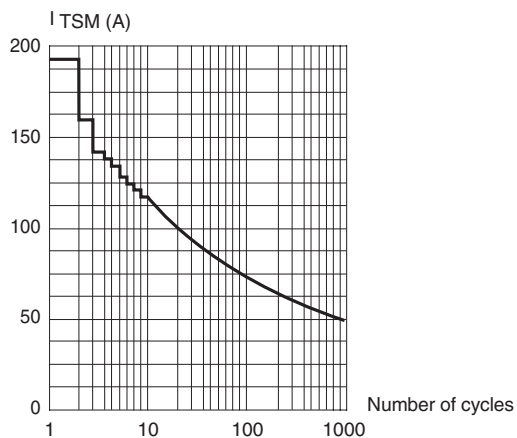
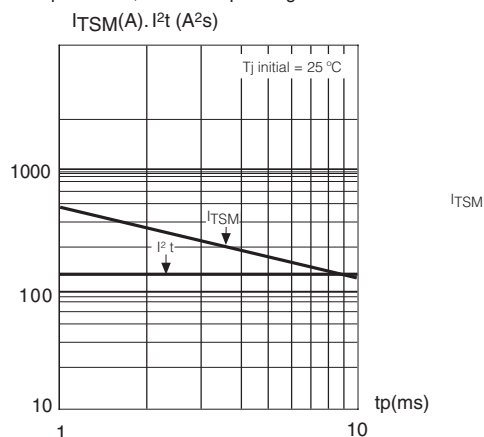
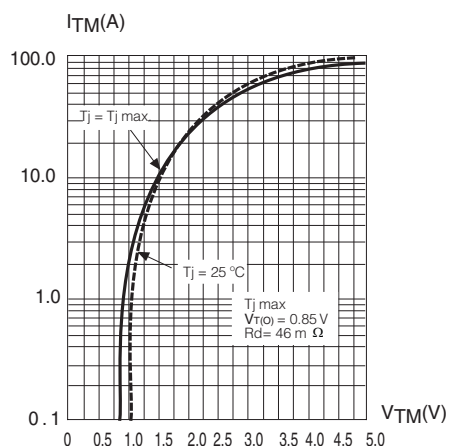


Fig. 6: Non repetitive surge peak on-state current for a sinusoidal pulse with width: $t_p < 10$ ms, and corresponding value of $I^2 t$.



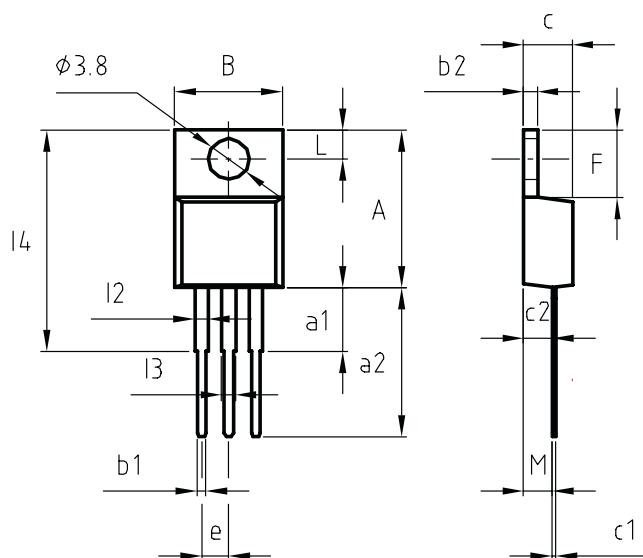
STANDARD SCR

Fig. 7: On-state characteristics (maximum values).



PACKAGE MECHANICAL DATA

TO-220AB



REF.	DIMENSIONS		
	Milimeters		
	Min.	Nominal	Max.
A	15.20		15.90
a1		3.75	
a2	13.00		14.00
B	10.00		10.40
b1	0.61		0.88
b2	1.23		1.32
C	4.40		4.60
c1	0.49		0.70
c2	2.40		2.72
e	2.40		2.70
F	6.20		6.60
l	3.75		3.85
l4	15.80	16.40	16.80
L	2.65		2.95
l2	1.14		1.70
l3	1.14		1.70
M		2.60	

Mounting Torque

1 N.m

(*) Limiting values and life support applications, see Web page.